

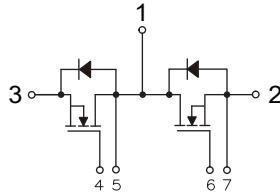


Silicon Carbide Enhancement Mode MOSFET

Features

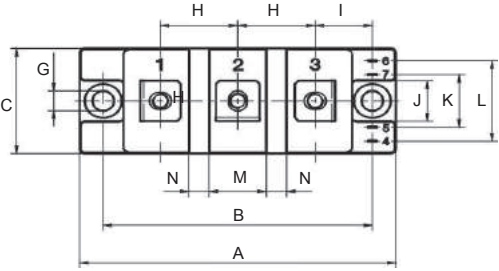
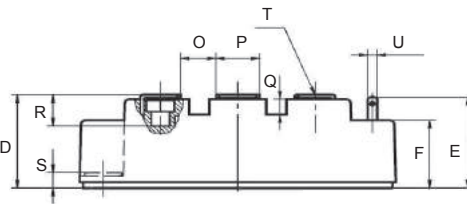
- ◆ $V_{DSS} = 1200V$
- ◆ $R_{DS(ON)} < 20m\Omega @ V_{GS} = 20V$
- ◆ Fully Avalanche Rated
- ◆ Pb Free & RoHS Compliant
- ◆ Isolation Type Package
- ◆ Electrically Isolation base plate

Preliminary



Applications

- ◆ Solar Inverters
- ◆ Power Converters
- ◆ Motor Drive
- ◆ Switch Mode Power Supplies
- ◆ Battery Chargers



Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	1200	V
Gate-Source Voltage	V_{GS}	-5/+20	V
Drain Current-Continuous @ $T_c = 25^\circ C$ @ $T_c = 100^\circ C$	I_D	168 110	A
Drain Current-Pulsed @ $T_c = 25^\circ C$ ^{Note1}	I_{DM}	400	A
Maximum Power Dissipation	P_D	580	W
Storage Temperature Range	T_{STG}	-50 to +150	°C
Operating Junction Temperature Range	T_J	-50 to +150	°C
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.22	°C/W
Isolation Voltage (A.C. 1 minute)	V_{iso}	4000	V
Mounting torque (M5 Screw)	M_d	3-5	N _m

DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MXA	MIN	MXA	
A	...	3.700	...	94.0	
B	3.134	3.165	79.6	80.4	
C	...	1.339	...	34.0	
D	...	1.201	...	30.5	
E	...	1.181	...	30.0	
F866	...	22.0	
G252	...	6.4	Ø
H	.894	.917	22.7	23.3	
I670	...	17.0	
J512	...	13.0	
K677	...	17.2	
L	...	1.024	...	26.0	
M699	...	17.0	
N236	...	6.0	
O413	...	10.5	
P512	...	13.0	
Q217	...	5.5	
R512	...	13.0	
S197	...	5.0	
T	M5				
U	...	110*20	...	2.8*0.5	



Electrical Characteristics @ T_J =25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
OFF Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V , I _{DS} =100uA	1200	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} =0V , V _{DS} =1200V	-	-	200	uA
Gate-Body Leakage	I _{GSS}	V _{GS} =±20V , V _{DS} =0V	-	-	200	nA
ON Characteristics						
Gate Threshold Voltage	V _{TH}	V _{DS} =V _{GS} , I _{DS} =8mA	2.0	2.5	3.5	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =20V , I _{DS} =100A	-	16	20	mΩ
Gate Resistance	R _G		-	1.6	2.9	Ω
Forward Transconductance	g _{fs}	V _{DS} =20V , I _D =100A ^{Note1}	-	30	-	S
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =800V V _{GS} =0V	-	6000	-	pF
Output Capacitance	C _{oss}	V _{AC} =25mV	-	368	-	
Reverse Transfer Capacitance	C _{rss}	Freq.=1MHz	-	80	-	
Turn-On Switching Energy	E _{on}	V _{DD} =800V , V _{GS} =-5V/+20V I _D =100A , R _{G(ext)} =5.1Ω	-	3.9	-	mJ
Turn-Off Switching Energy	E _{off}	Load=200μH , T _J =125°C	-	1.8	-	
Switching Characteristics						
Turn-On Delay Time	t _{d(on)}	V _{DD} =600V	-	41	-	ns
Rise Time	t _r	V _{GS} =20V	-	30	-	
Turn-Off Delay Time	t _{d(off)}	I _{DS} =150A	-	72	-	
Fall Time	t _f	R _G =2.5Ω	-	30	-	
Total Gate Charge at 10V	Q _g	V _{DS} =800V	-	360	-	nC
Gate to Source Charge	Q _{gs}	V _{GS} =20V	-	90	-	
Gate to Drain Charge	Q _{gd}	I _{DS} =100A	-	98	-	
Reverse Diode Characteristics						
Drain-Source Diode Forward Voltage	V _F	T _J =25°C , I _F =168A	-	-	6.5	V
Diode Continuous Forward Current	I _F		-	-	110	A
Diode Pulsed Current ^{Note1}	I _{F,pulse}		-	-	400	A
Reverse Recovery time	T _{RR}	I _F =0.5V , I _R =1.0A , I _{RR} =0.25A	-	-	185	ns

Notes:

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle > 2%.



Typical Characteristics

Figure 1. Maximum Power Dissipation (MOSFET) Derating vs. Case Temperature

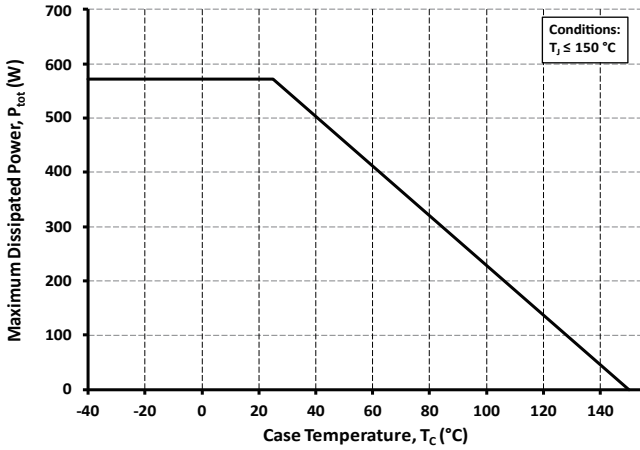


Figure 2. Continuous Drain Current (MOSFET) Derating vs Case Temperature

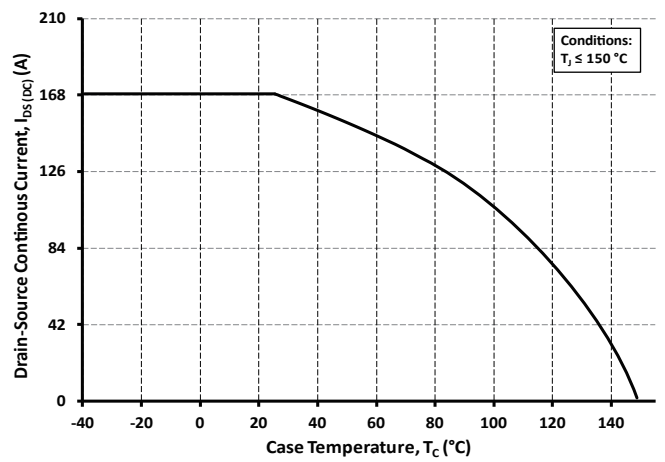


Figure 3. Maximum Power Dissipation (MOSFET) Derating vs. Case Temperature

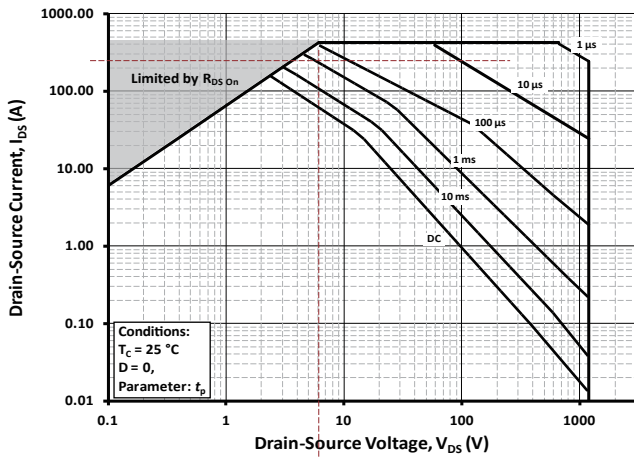


Figure 4. MOSFET Junction to Case Thermal Impedance

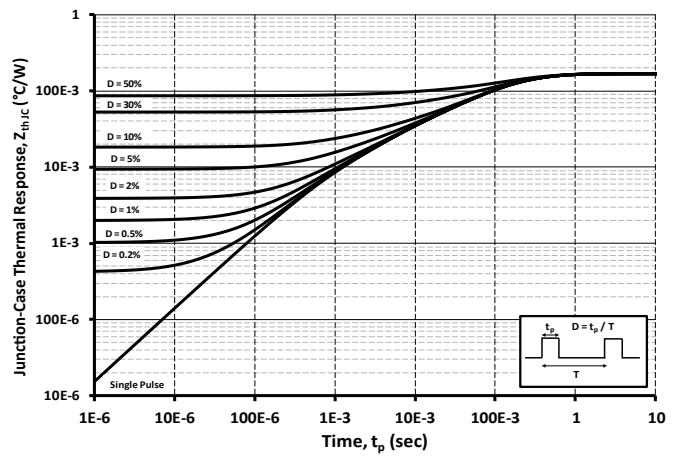


Figure 5. Output Characteristics T_j = 25 °C

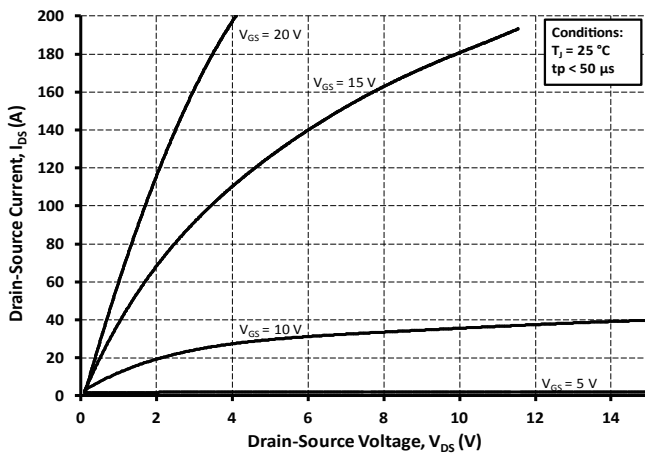
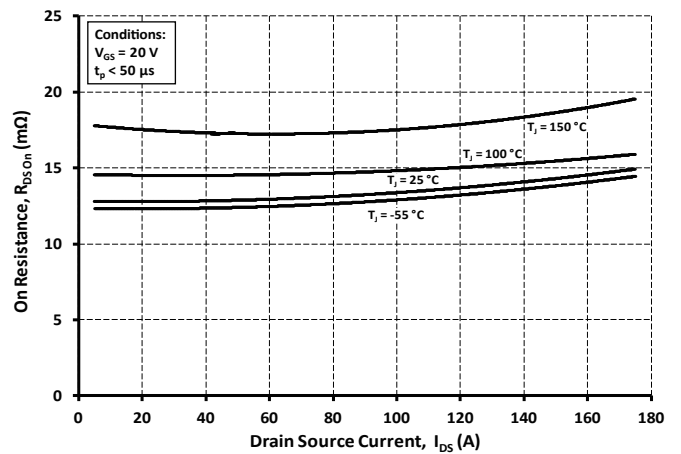


Figure 6. On-Resistance vs. Drain Current For Various Temperatures





Typical Characteristics

Figure 7. On-Resistance vs. Temperature For Various Gate-Source Voltage

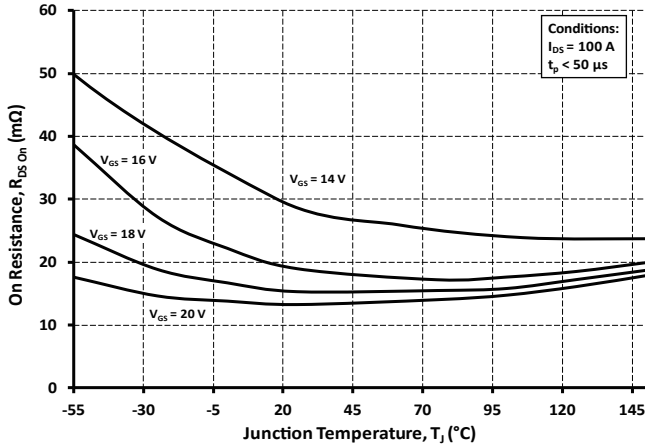


Figure 8. Threshold Voltage vs. Temperature

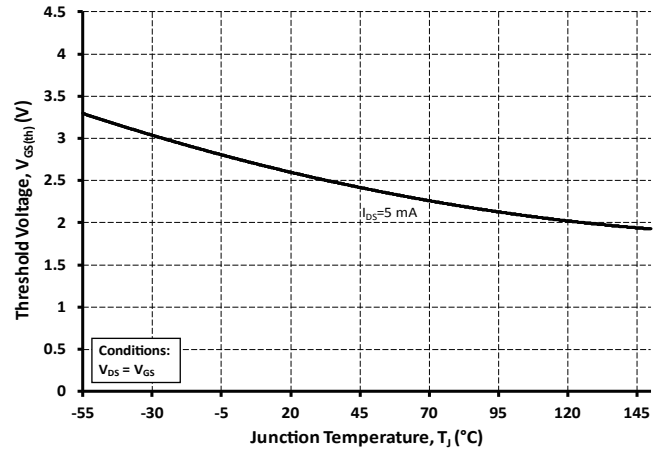


Figure 9. Transfer Characteristic for Various Junction Temperatures

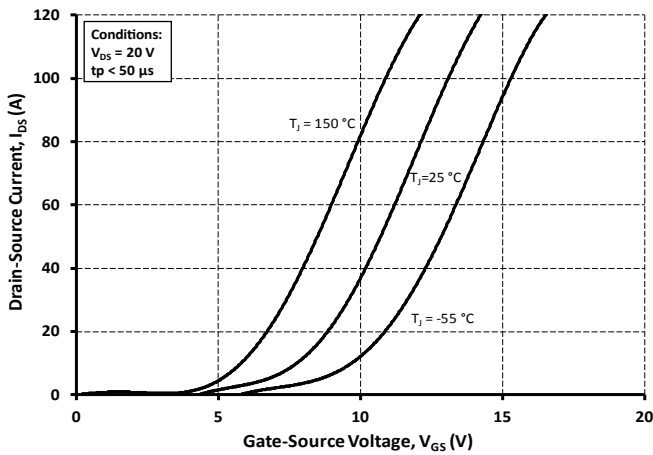


Figure 10. Capacitances vs. Drain-Source Voltage (0 - 1 kV)

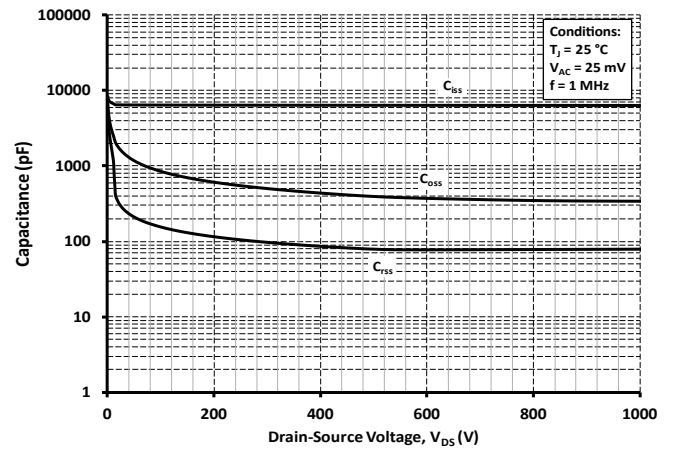


Figure 11. Typical forward characteristics of reverse diode

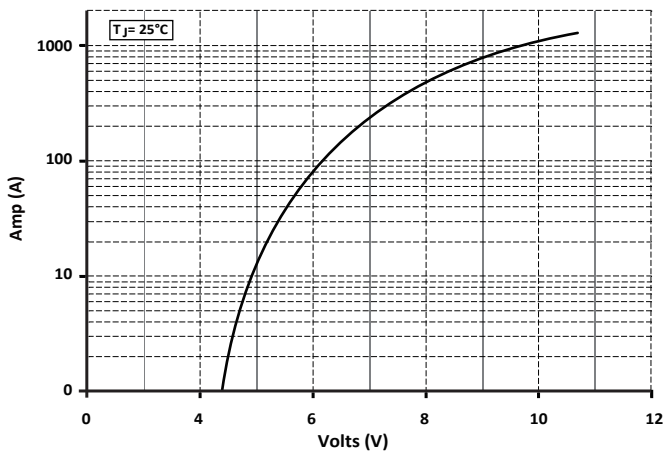
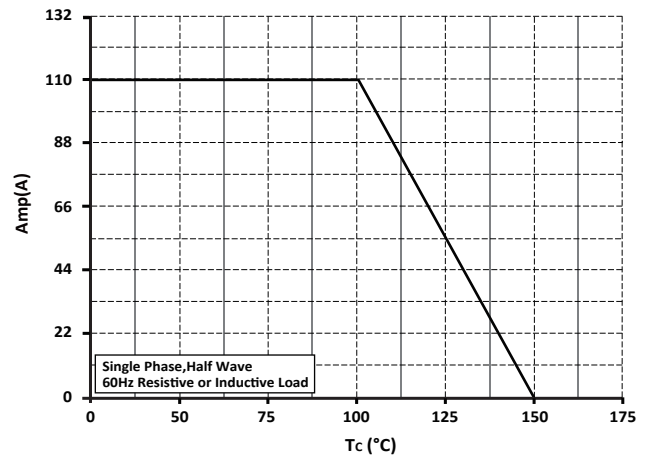


Figure 12. Forward derating curve of reverse diode





Typical Characteristics

Figure 13. Peak forward surge current of reverse diode

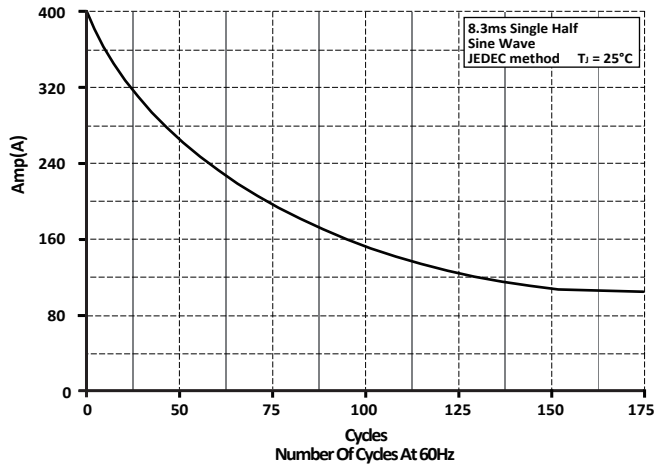


Figure 14. Typical reverse diode characteristics

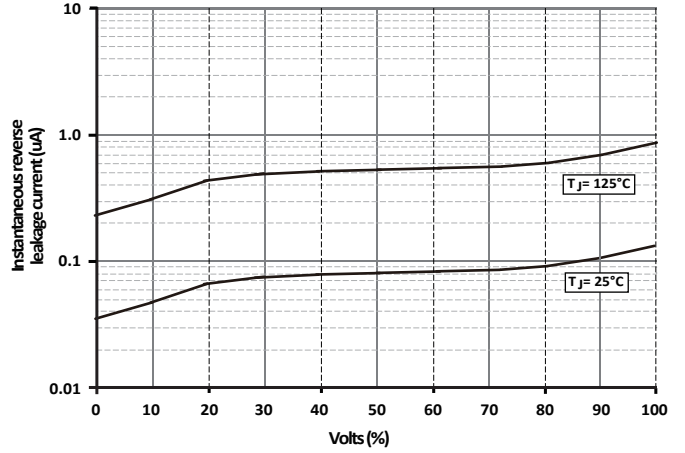


Figure 15. Gate Charge Characteristics

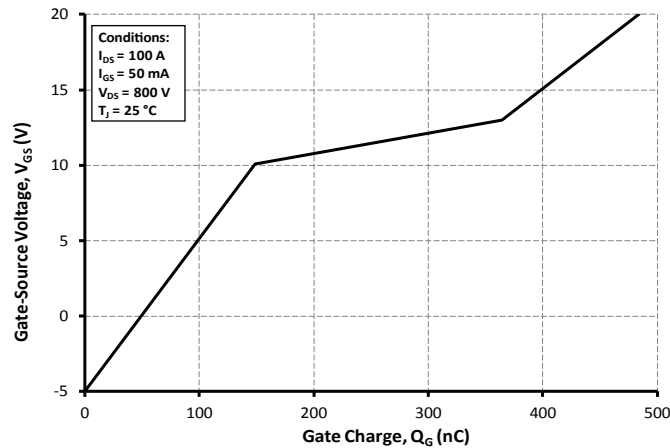


Figure 16. Inductive Switching Energy vs. Temperature

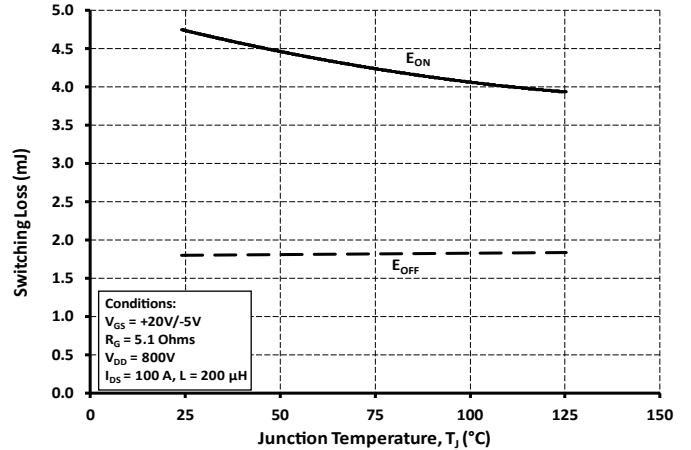


Figure 17. Timing vs. R_{G(ext)}

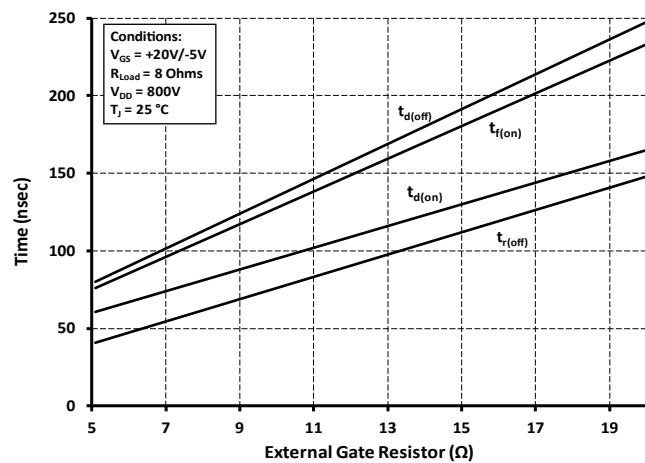
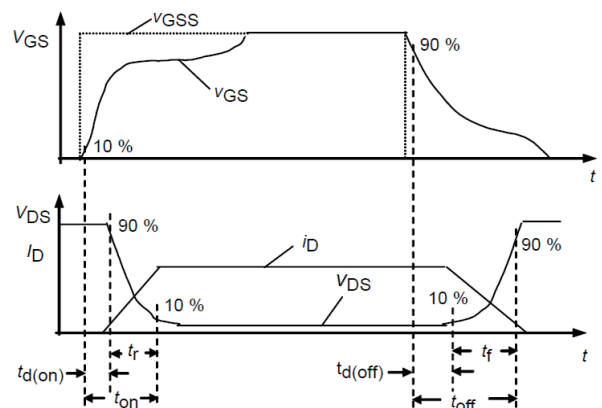


Figure 18. Resistive Switching Time Description



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